ECE 574 – Cluster Computing Lecture 21

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Announcements

- HW#9 Was Posted
 Brief power measurement. Only trick is two windows for CUDA measurement

 Be sure to look at HW before exam, will be drawing
 - from all homework questions
- Could still use a few volunteers to present a week from today



Midterm Review

- Speedup/Parallel efficiency
- Tradeoffs. Given code and hardware, would you use MPI, pthreads, CUDA, etc?
- OpenMP: dynamic vs static scheduling. Parallel for
- MPI
- GPGPU/CUDA: read code, know about cudaMalloc, cudaMemcpy



- BigData: sizes involved
- Hadoop: Map/Recuce, Java, Uses distributed filesystem
- Reliability. Causes of errors. Tradeoffs of Checkpointing
- Energy, Energy Delay, Time, Performance
- Exaflop Challenge



Roadmap to Exascale

- https://www.top500.org/news/the-four-way-race-t
- Japan, China, France, US
- Goal between 2020 and 2023
- Build a meaningful machine. Can scale up current tech, but it would be insanely power hungry and jobs wouldn't scale (it would be just a job-sharing cluster)
- US Plan 2023. DoE. Money to companies (suspected



IBM, Cray, Intel, NVIDIA). Same as CORAL 100PFLOP machines (Collaboration of Oak Ridge, Argonne, and Livermore). Likely IBM Power/NVIDIA GPU/Mellanox InfiniaBand or Intel Xeon Phi/Omni-Path

- Japan 2020, Likely a Riken K-computer followup
- China 2020, homegrown, as in 2015 US banned selling supercomputer to china
- France 2020, Atos/Bull. Likely Intel Xeon/Xeon-Phi



Roadmap to Exascale

- Paul Messina interview (Argonne)
- https://www.hpcwire.com/2016/06/14/us-carves-pa
- Looking for Capable Exascale not Exaflop (defined as can calculate 50x faster than 20PFLOP machine and using 20-30MW)
- Broad societal benefits, not just bragging rights
- Interesting graph showing contribution from CMOS



scaling leveling off

ullet Exaflop system 20MW and cost 200million, then a pet a flop



McCalpin Talk

- http://sites.utexas.edu/jdm4372/2016/11/22/sc16
- Heterogeneous clusters, some machines with lots of cores, some with lots of memory, can choose.
- Peak FLOPS/socket increasing 50% year
- Memory Bandwidth increasing 23% year
- Memory Latency increasing 4% year



- Interconnect Bandwidth increasing 20% year
- Interconnect Latency decreasing 20% year
- Why memory so bad? Emphasis on size. 64-bit wide internally not increased. Pins cost money.
- Coherency can dominate performance.
- Power/Energy a concern
- Haswell can only run LINPACK on half the cores before it has to downthrottle



- Power does not matter in operation cost? 2500/socket, 100W, 40Wcooling, .10/kWh, 5% of purchase price per year
- This may change with mobile chips



Exascale

- ullet Exascale computing Exaflop = 1000 Petaflops / 1M Teraflops
- Petascale in 2008, estimated Exascale was in 2018 2020 but keeps being pushed back.
- Current fastest roughly 40 Petaflops
- Envision as having 100k nodes, each with 10Tflop; modern high-end GPUs only about 3Tflop (double precision)
- Many challenges



DOE

- US Department of Energys objectives and requirements for exascale systems
- Had series of workshops 2008 2012 to discuss what is needed



Power

- Biggest challenge going forward
- Power costs of largest system \$5-10million
- Exascale with current tech would need 350 megawatts (\$250 million/year)
- To be feasible really need to cap at 20 megawatts
- Data movement historically 1byte/flop considered reasonable



But for current 2Petaflops system that would take 1.25MW

Even if reduce to bare minimum (0.2byte/flop) would be 50MW for exascale.

Proposed: more energy-efficient hardware, Si-photonic communication, power-aware algorithms



Concurrency

- Already can't keep cores busy to mask long-latency (usually memory) events
- Flattening of CPU clock frequency is keeping things from getting worse, but having more cores making requests is not helping
- With exascale, costs more energy to transport data than to compute it.



Fault Tolerance

- Mean Time To Interrupt (MTTI)
- Improve MTTI so applications can run for hours without faults



RAM

- Current power levels unsustainable
- Slowing technology growth, from 4-times per 3 years to
 2-times per three years
- Limiting factor in most applications
- Need 4TBpbs bandwidth and 1TB per node
 Current DIMMs have single-digit number of channels with 10s of GB/s



DRAM Performance Metrics

- Energy per bit
- Aggregate bandwidth per socket
- Memory capacity per socket
- FIT rate per node
- Error detection
- Processing in Memory
- Programmability



Programmability

- Three stages: algorithm capture, correctness debugging, performance optimization
- Parallelism anticipated that 10-billion-way concurrency needed
- Distributed Resource Allocation need to spread out to parallel, but also need to keep close for low-latency
- Latency Hiding overlap communication with computation



- Hardware idiosyncrasies allow using fast novel hardware without burdening programmer too much with the details
- Portability use software across machine types
- Synchronization barriers are expensive operations, replace by lightweight (transactional memory?)



CPU/Network

Not really worried about CPU or Network?



AMD: Achieving Exascale Capabilities Through Heterogeneous Computing

- APU (CPU combined with GPU), 3D-RAM, connected to off-core NVRAM
- CPU handles serial sections, GPUs parallel sections
- APU exascale heterogeneous processor (EHP)
 Supports HSA (Heterogeneous System Architecture) –
 CPU and GPU have same shared memory space, CPU and GPU can trade pointers w/o going over PCIe bus



CPU – 32 cores (ARM or x86) CPU only possible, but probably not have high enough perf/W why integrated? lower overhead. Also higher FLOPS/volume (meters cubed)

- 2.5D interposer-based stacking vs 3d? (3d has through vias CPU to DRAM, 2.5d the dram stack is next to CPU with interposer board to connect)
- QuickRelease and HRF (heterogeneous-race-free) need complex setup to get cache coherency between GPU and



CPU

- JEDEC high-bandwidth memory (HBM) standard 128
 GBps per DRAM stack. With eight stacks, TBps with current tech.
- Three levels of memory (fast, NVRAM, flash?)
- How to use memory? Transparent like current, or expose to user?
- DRAM power even if reduce from current 60pJ/bit of DDR3 to 2pJ/bit, 4TBps could consume half of the



power of entire cluster

- Processor in memory (PIM) can maybe provide better energy efficiency
- How to program?
- Reliability? GPUs not typically as reliable as CPUs.
 Corruption in GPU output not considered as critical as in CPU



Intel's Exascale Plan

- Can't find a nice article like for AMD.
- Knight's Landing?
- 14nm successor to Knights Corner
- AVX-512, Multi-Channel DRAM (MCDRAM), Silvermont based CPU core
- 76 cores (72 with 4 spares)
- Omni-path interconnect, says it is more power efficient than InfiniBand



New IBM Supercomputers

